

PRODUCT CHANGE NOTICE

1. TITLE IRF130 series, Fab transfer	2. DOCUMENT NUMBER FV5-C-18-0056
	3. DATE May 1, 2018






4. MANUFACTURER AND ADDRESS International Rectifier 205 Crawford Street Leominster, MA 01453	5. MANUFACTURER PART NUMBER See below for IR Part Numbers
	6. BASE PART NA
	7. NATIONAL STOCK NUMBER (NSN) NA

8. CAGE 69210	9. EFFECTIVE DATE May 1, 2018	10. GOVERNMENT NUMBER NA
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11. POINT OF CONTACT Manufacturer's Representative or Customer Service Representative (978) 534-5776	12. DRAWING NUMBER NA
	13. SPECIFICATION NUMBER MIL-PRF-19500

14. PRODUCT CHANGE

This GIDEP PCN is to announce the qualification of new wafer fabrication site for the following International Rectifier Part No.

Part (jedec #)	Description	Package
IRFY130, IRFY130M	100V, N-CHANNEL, HEXFET® MOSFET, TO-257 package	
IRFY130C, IRFY130CM	100V, N-CHANNEL, HEXFET® MOSFET, TO-257 package	
IRF130 (2N6756)	100V, N-CHANNEL, HEXFET® MOSFET, TO-204AA package	
IRFF130 (2N6796)	100V, N-CHANNEL, HEXFET® MOSFET, TO-205AF package	
IRFE130 (2N6796U)	100V, N-CHANNEL, HEXFET® MOSFET, 18-pin LCC package	


Change

Transfer (Vishay Intertechnology) die fabrication from International Rectifier (FAB 1) in Temecula, CA to Tower Semiconductor in Migdal Haemek, Israel.

Impact of Change:

There will be no impact to the fit, form, function, quality or reliability of the parts. There will be no change to the datasheet parameters.

16. APPROVING GOVERNMENT ACTIVITY		
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17. GIDEP REPRESENTATIVE Paul Hebert	18. SIGNATURE 	19. DATE May 1, 2018
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